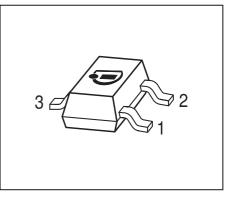


BFR181

NPN Silicon RF Transistor*

- For low noise, high-gain broadband amplifiers at collector currents from 0.5 mA to 12 mA
- $f_{\rm T}$ = 8 GHz, *F* = 0.9 dB at 900 MHz
- Pb-free (RoHS compliant) package¹⁾
- Qualified according AEC Q101
- * Short term description





ESD (Electrostatic discharge) sensitive device, observe handling precaution!

Туре	Marking		Pin Conf	iguration	Package SOT23	
BFR181	RFs	1=B	2=E	3=C		
Maximum Ratings						
Parameter			Symbol	Value	Unit	
Collector-emitter voltage			V _{CEO}	12	V	
Collector-emitter voltage			V _{CES}	20		
Collector-base voltage			V _{CBO}	20		
Emitter-base voltage			V _{EBO}	2		
Collector current			I _C	20	mA	
Base current			I _B	2		
Total power dissipation ²⁾	l power dissipation ²⁾		P _{tot}	175	mW	
<i>T</i> _S ≤ 91 °C						
Junction temperature		T _i	150	°C		
Ambient temperature		T _A	-65 15	0		
Storage temperature			T _{stg}	-65 15	0	
Thermal Resistance						
Parameter			Symbol	Value	Unit	

Parameter	Symbol	Value	Unit
Junction - soldering point ³⁾	R _{thJS}	≤ 335	K/W

¹Pb-containing package may be available upon special request

 $^2{\cal T}_S$ is measured on the collector lead at the soldering point to the pcb

³For calculation of R_{thJA} please refer to Application Note Thermal Resistance



Parameter	Symbol	Values			Unit	
		min.	typ.	max.		
DC Characteristics						
Collector-emitter breakdown voltage	V _{(BR)CEO}	12	-	-	V	
<i>I</i> _C = 1 mA, <i>I</i> _B = 0						
Collector-emitter cutoff current	I _{CES}	-	_	100	μA	
V _{CE} = 20 V, V _{BE} = 0						
Collector-base cutoff current	I _{CBO}	-	-	100	nA	
$V_{\rm CB}$ = 10 V, $I_{\rm E}$ = 0						
Emitter-base cutoff current	I _{EBO}	-	-	1	μA	
$V_{\rm EB}$ = 1 V, $I_{\rm C}$ = 0						
DC current gain-	h _{FE}	70	100	140	-	
$I_{\rm C}$ = 5 mA, $V_{\rm CE}$ = 8 V, pulse measured						

Electrical Characteristics at $T_A = 25^{\circ}C$, unless otherwise specified



Parameter	Symbol	Values			Unit		
		min.	typ.	max.			
AC Characteristics (verified by random sampling)							
Transition frequency	f _T	6	8	-	GHz		
<i>I</i> _C = 10 mA, <i>V</i> _{CE} = 8 V, <i>f</i> = 500 MHz							
Collector-base capacitance	C _{cb}	-	0.27	0.45	pF		
$V_{CB} = 10 \text{ V}, f = 1 \text{ MHz}, V_{BE} = 0$,							
emitter grounded							
Collector emitter capacitance	C _{ce}	-	0.2	-			
$V_{CE} = 10 \text{ V}, f = 1 \text{ MHz}, V_{BE} = 0$,							
base grounded							
Emitter-base capacitance	C _{eb}	-	0.35	-			
$V_{\rm EB}$ = 0.5 V, f = 1 MHz, $V_{\rm CB}$ = 0 ,							
collector grounded							
Noise figure	F				dB		
$I_{\rm C}$ = 2 mA, $V_{\rm CE}$ = 8 V, $Z_{\rm S}$ = $Z_{\rm Sopt}$,							
<i>f</i> = 900 MHz		-	0.9	-			
$I_{\rm C}$ = 2 mA, $V_{\rm CE}$ = 8 V, $Z_{\rm S}$ = $Z_{\rm Sopt}$,							
<i>f</i> = 1.8 GHz		-	1.2	-			
Power gain, maximum stable ¹⁾	G _{ms}	-	18.5	-	dB		
$I_{\rm C}$ = 10 mA, $V_{\rm CE}$ = 8 V, $Z_{\rm S}$ = $Z_{\rm Sopt}$, $Z_{\rm L}$ = $Z_{\rm Lopt}$,							
<i>f</i> = 900 MHz							
Power gain, maximum available ²⁾	G _{ma}	-	12.5	-	dB		
$I_{\rm C}$ = 5 mA, $V_{\rm CE}$ = 8 V, $Z_{\rm S}$ = $Z_{\rm Sopt}$, $Z_{\rm L}$ = $Z_{\rm Lopt}$,							
<i>f</i> = 1.8 GHz							
Transducer gain	S _{21e} ²				dB		
$I_{\rm C}$ = 5 mA, $V_{\rm CE}$ = 8 V, $Z_{\rm S}$ = $Z_{\rm L}$ = 50 Ω ,							
<i>f</i> = 900 MHz		-	14.5	-			
$I_{\rm C}$ = 5 mA, $V_{\rm CE}$ = 8 V, $Z_{\rm S}$ = $Z_{\rm L}$ = 50 Ω ,							
<i>f</i> = 1.8 MHz		-	9.5	-			

Electrical Characteristics at $T_A = 25^{\circ}$ C, unless otherwise specified

 ${}^{1}G_{\rm ms} = |S_{21} / S_{12}|$

 ${}^{2}G_{\text{ma}} = |S_{21e} / S_{12e}| \ (k - (k^{2} - 1)^{1/2})$

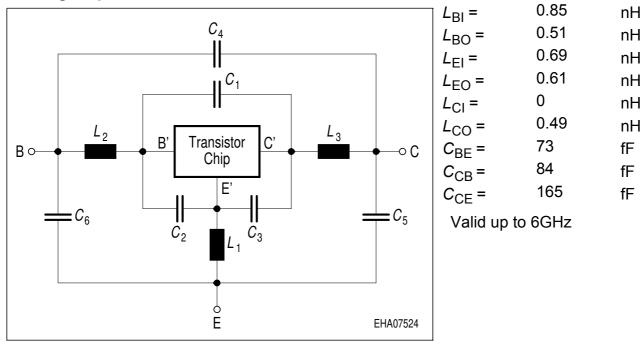


SPICE Parameter (Gummel-Poon Model, Berkley-SPICE 2G.6 Syntax):

IS =	0.0010519	fA	BF =	96.461	-	NF =	0.90617	-
VAF =	22.403	V	IKF =	0.12146	А	ISE =	12.603	fA
NE =	1.7631	-	BR =	16.504	-	NR =	0.87757	-
VAR =	5.1127	V	IKR =	0.24951	А	ISC =	0.01195	fA
NC =	1.6528	-	RB =	9.9037	Ω	IRB =	0.69278	mΑ
RBM =	6.6315	Ω	RE =	2.1372	-	RC =	2.2171	Ω
CJE =	1.8168	fF	VJE =	0.73155	V	MJE =	0.43619	-
TF =	17.028	ps	XTF =	0.33814	-	VTF =	0.12571	V
ITF =	1.0549	mA	PTF =	0	deg	CJC =	319.69	fF
VJC =	1.1633	V	MJC =	0.30013	-	XCJC =	0.082903	-
TR =	2.7449	ns	CJS =	0	fF	VJS =	0.75	V
MJS =	0	-	XTB =	0	-	EG =	1.11	eV
XTI =	3	-	FC =	0.99768		TNOM	300	K

All parameters are ready to use, no scalling is necessary. Extracted on behalf of Infineon Technologies AG by: Institut für Mobil- und Satellitentechnik (IMST)

Package Equivalent Circuit:



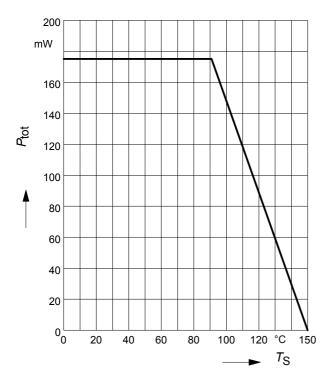
For examples and ready to use parameters please contact your local Infineon Technologies distributor or sales office to obtain a Infineon Technologies CD-ROM or see Internet: http://www.infineon.com



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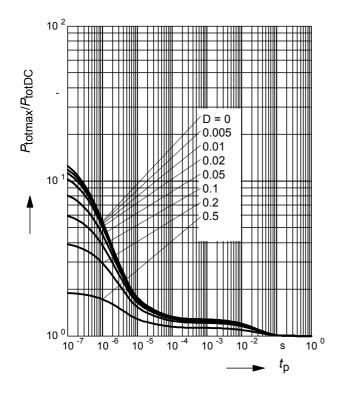
Total power dissipation $P_{tot} = f(T_S)$

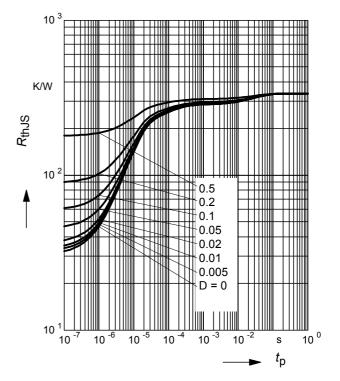
Permissible Pulse Load $R_{\text{thJS}} = f(t_p)$



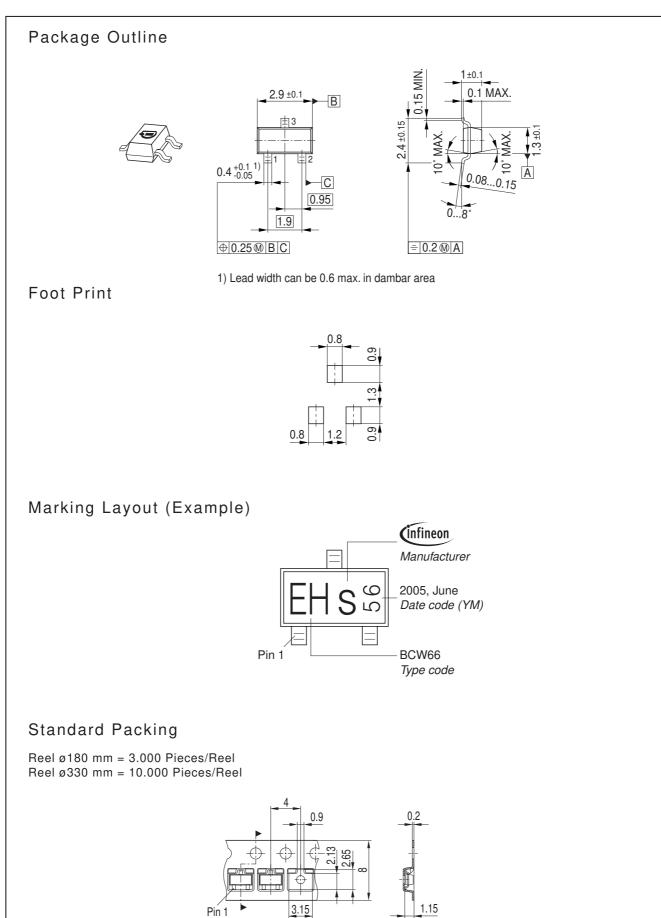
Permissible Pulse Load

 $P_{\text{totmax}}/P_{\text{totDC}} = f(t_{p})$











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